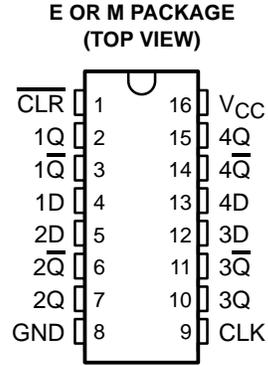


- Inputs Are TTL-Voltage Compatible
- Contains Four Flip-Flops With Double-Rail Outputs
- Buffered Inputs
- Speed of Bipolar F, AS, and S, With Significantly Reduced Power Consumption
- Balanced Propagation Delays
- ±24-mA Output Drive Current
  - Fanout to 15 F Devices
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Exceeds 2-kV ESD Protection Per MIL-STD-883, Method 3015
- Applications Include:
  - Buffer/Storage Registers
  - Shift Registers
  - Pattern Generators



**description/ordering information**

This positive-edge-triggered D-type flip-flop has a direct clear ( $\overline{\text{CLR}}$ ) input. The CD74ACT175 features complementary outputs from each flip-flop.

Information at the data (D) inputs meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going edge of CLK. When CLK is at either the high or low level, the D input has no effect at the output.

**ORDERING INFORMATION**

T <sub>A</sub>	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	–55°C to 125°C	PDIP – E	Tube	CD74ACT175E
SOIC – M		Tube	CD74ACT175M	ACT175M
		Tape and reel	CD74ACT175M96	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

**FUNCTION TABLE**  
(each flip-flop)

INPUTS			OUTPUTS	
$\overline{\text{CLR}}$	CLK	D	Q	$\overline{\text{Q}}$
L	X	X	L	H
H	↑	H	H	L
H	↑	L	L	H
H	L	X	Q <sub>0</sub>	$\overline{\text{Q}}_0$



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



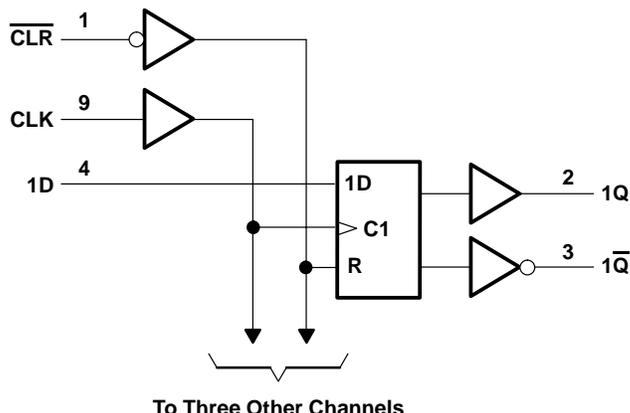
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# CD74ACT175 QUADRUPLE D-TYPE FLIP-FLOP WITH CLEAR

SCHS345 – APRIL 2003

## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$	-0.5 V to 6 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ V or $V_I > V_{CC}$ ) (see Note 1)	$\pm 20$ mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ V or $V_O > V_{CC}$ ) (see Note 1)	$\pm 50$ mA
Continuous output current, $I_O$ ( $V_O > 0$ V or $V_O < V_{CC}$ )	$\pm 50$ mA
Continuous current through $V_{CC}$ or GND	$\pm 200$ mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): E package	67°C/W
M package	73°C/W
Storage temperature range, $T_{stg}$	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 3)

	$T_A = 25^\circ\text{C}$		$-55^\circ\text{C to } 125^\circ\text{C}$		$-40^\circ\text{C to } 85^\circ\text{C}$		UNIT
	MIN	MAX	MIN	MAX	MIN	MAX	
$V_{CC}$ Supply voltage	4.5	5.5	4.5	5.5	4.5	5.5	V
$V_{IH}$ High-level input voltage	2		2		2		V
$V_{IL}$ Low-level input voltage		0.8		0.8		0.8	V
$V_I$ Input voltage	0	$V_{CC}$	0	$V_{CC}$	0	$V_{CC}$	V
$V_O$ Output voltage	0	$V_{CC}$	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$ High-level output current		-24		-24		-24	mA
$I_{OL}$ Low-level output current		24		24		24	mA
$\Delta t/\Delta v$ Input transition rise or fall rate		10		10		10	ns/V

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS		V <sub>CC</sub>	T <sub>A</sub> = 25°C		–55°C to 125°C		–40°C to 85°C		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
V <sub>OH</sub>	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = –50 μA	4.5 V	4.4		4.4		4.4	V	
		I <sub>OH</sub> = –24 mA	4.5 V	3.94		3.7		3.8		
		I <sub>OH</sub> = –50 mA†	5.5 V			3.85				
		I <sub>OH</sub> = –75 mA†	5.5 V					3.85		
V <sub>OL</sub>	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	4.5 V		0.1		0.1	0.1	V	
		I <sub>OL</sub> = 24 mA	4.5 V		0.36		0.5	0.44		
		I <sub>OL</sub> = 50 mA†	5.5 V				1.65			
		I <sub>OL</sub> = 75 mA†	5.5 V					1.65		
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND		5.5 V		±0.1		±1	±1	μA	
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0		5.5 V		8		160	80	μA	
ΔI <sub>CC</sub> ‡	V <sub>I</sub> = V <sub>CC</sub> – 2.1 V		4.5 V to 5.5 V		2.4		3	2.8	mA	
C <sub>i</sub>					10		10	10	pF	

† Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.

‡ Additional quiescent supply current per input pin, TTL inputs high, 1 unit load

**ACT INPUT LOAD TABLE**

INPUT	UNIT LOAD
Data	0.58
CLR	0.67
CLK	0.92

Unit Load is ΔI<sub>CC</sub> limit specified in electrical characteristics table (e.g., 2.4 mA at 25°C).

**timing requirements over recommended operating free-air temperature range, V<sub>CC</sub> = 5 V ± 0.5 V (unless otherwise noted)**

		–55°C to 125°C		–40°C to 85°C		UNIT
		MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency		114		114	MHz
t <sub>w</sub>	Pulse duration	CLR low		4	3.5	ns
		CLK high or low		5	4.4	
t <sub>su</sub>	Setup time before CLK↑	Data		2	2	ns
t <sub>h</sub>	Hold time, data after CLK↑			2	2	ns
t <sub>rec</sub>	Recovery time, before CLK↑	CLR↑		1	1	ns

**CD74ACT175**  
**QUADRUPLE D-TYPE FLIP-FLOP**  
**WITH CLEAR**

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switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ ,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 1)

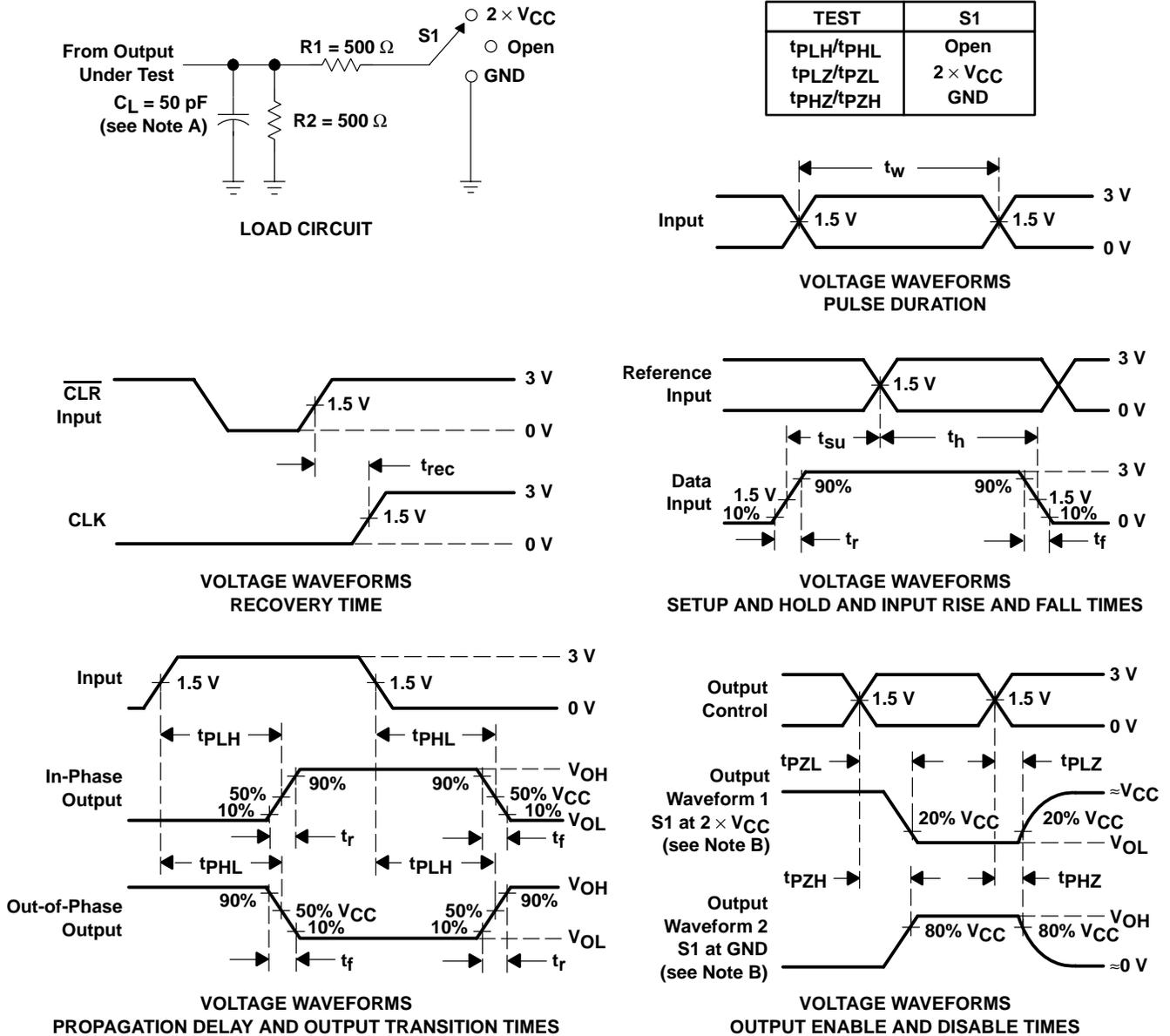
PARAMETER	FROM (INPUT)	TO (OUTPUT)	-55°C to 125°C		-40°C to 85°C		UNIT
			MIN	MAX	MIN	MAX	
$f_{max}$			114		114		MHz
$t_{PLH}$	CLK	Any Q	2.9	11.5	3	10.5	ns
$t_{PHL}$			2.9	11.5	3	10.5	
$t_{PLH}$	$\overline{\text{CLR}}$	Any Q	3.3	13	3.3	11.8	ns
$t_{PHL}$			3.3	13	3.3	11.8	

operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER		TYP	UNIT
$C_{pd}$	Power dissipation capacitance	55	pF



**PARAMETER MEASUREMENT INFORMATION**



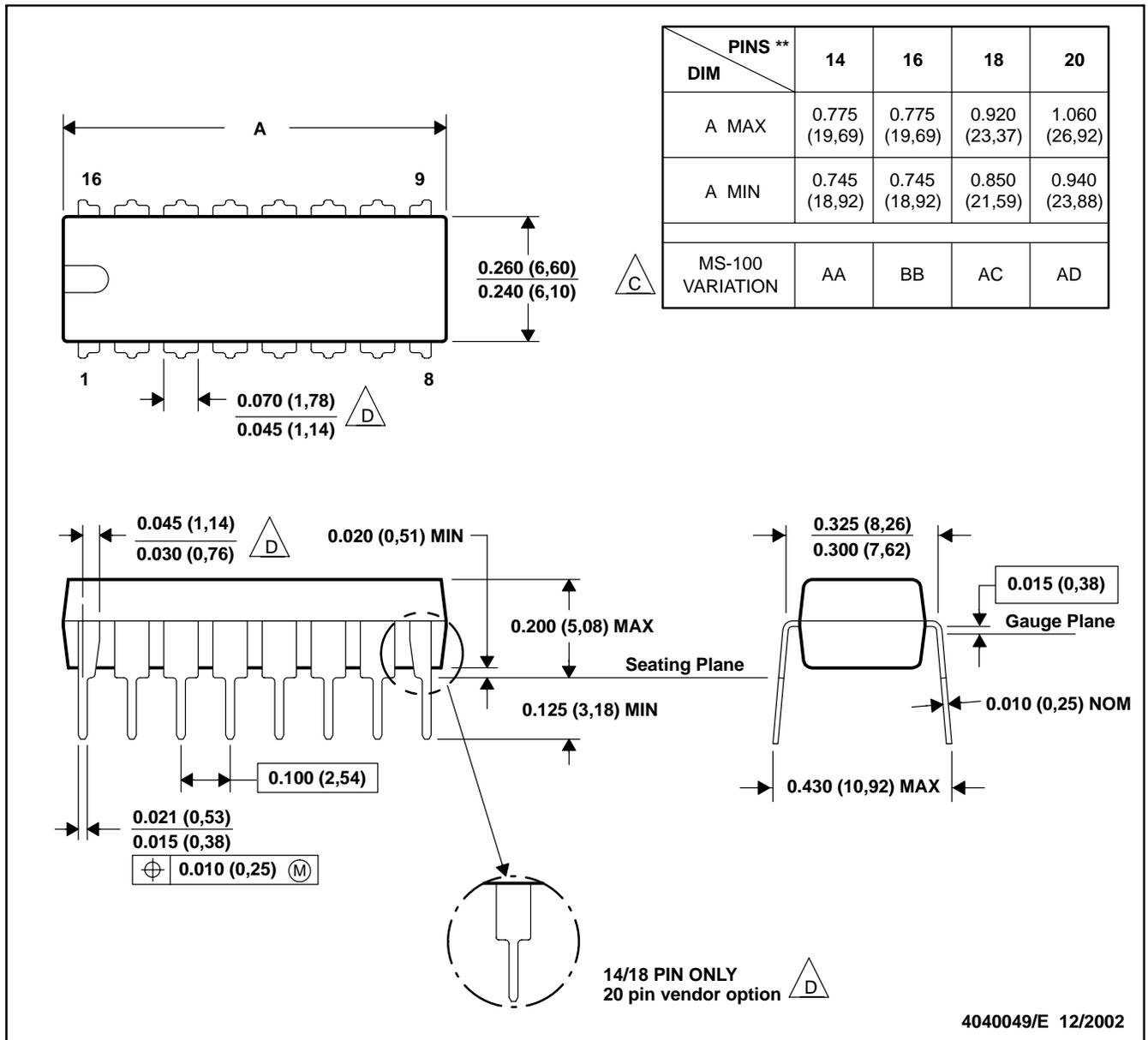
- NOTES:
- A.  $C_L$  includes probe and test-fixture capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1$  MHz,  $Z_O = 50 \Omega$ ,  $t_r = 3$  ns,  $t_f = 3$  ns. Phase relationships between waveforms are arbitrary.
  - D. For clock inputs,  $f_{max}$  is measured with the input duty cycle at 50%.
  - E. The outputs are measured one at a time with one input transition per measurement.
  - F.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - G.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - H.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - I. All parameters and waveforms are not applicable to all devices.

**Figure 1. Load Circuit and Voltage Waveforms**

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

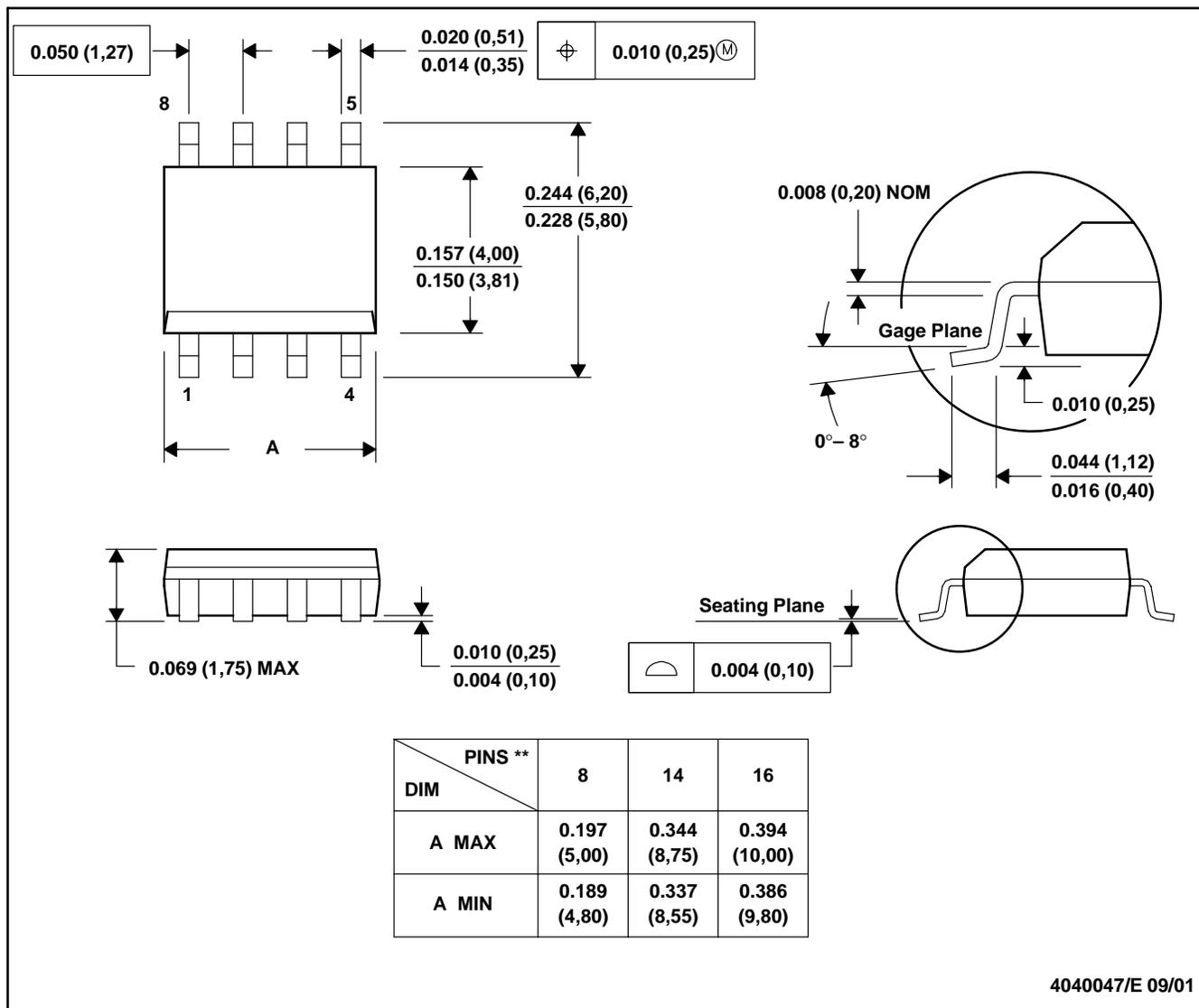


- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 D The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MS-012

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